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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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# MS2321

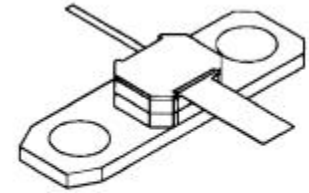
## RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS

### Features

- DESIGNED FOR HIGH POWER PULSED IFF, DME, AND TACAN APPLICATIONS
- 20 W (typ.) IFF 1030–1090 MHz
- 15 W (min.) DME 1025–1150 MHz
- 15 W (typ.) TACAN 960–1215 MHz
- 1025 - 1150 MHz
- 50 VOLT OPERATION
- $P_{OUT} = 15$  WATTS
- $G_P = 10$  dB MINIMUM
- 20:1 VSWR CAPABILITY @ RATED CONDITIONS
- COMMON BASE CONFIGURATION

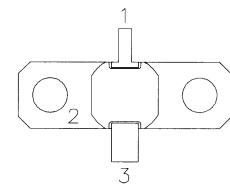
### DESCRIPTION:

The MS2321 is a gold metallized, silicon NPN power transistor designed for pulsed applications with low duty cycles such as IFF, DME and TACAN. Internal impedance matching is utilized for maximum broadband performance and simplified external matching.



**.250 SQ. 2LFL (M105)**  
hermetically sealed

### PIN CONNECTION



1. Collector  
2. Base  
3. Emitter

### ABSOLUTE MAXIMUM RATINGS ( $T_{case} = 25^{\circ}C$ )

Symbol	Parameter	Value	Unit
$V_{CBO}$	Collector-Base Voltage	65	V
$V_{CEO}$	Collector-Emitter Voltage	65	V
$V_{EBO}$	Emitter-Base Voltage	3.5	V
$I_C$	Device Current	1.5	A
$P_{DISS}$	Power Dissipation	87.5	W
$T_J$	Junction Temperature	+200	$^{\circ}C$
$T_{STG}$	Storage Temperature	-65 to +150	$^{\circ}C$

### Thermal Data

$R_{TH(J-C)}$	Junction-case Thermal Resistance	2.0	$^{\circ}C/W$
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**ELECTRICAL SPECIFICATIONS (T<sub>case</sub> = 25°C)**
**STATIC**

Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
<b>BV<sub>CBO</sub></b>	<b>I<sub>C</sub> = 10mA      I<sub>E</sub> = 0mA</b>	<b>65</b>	---	---	<b>V</b>
<b>BV<sub>CES</sub></b>	<b>I<sub>C</sub> = 25mA      V<sub>BE</sub> = 0V</b>	<b>65</b>	---	---	<b>V</b>
<b>BV<sub>EBO</sub></b>	<b>I<sub>E</sub> = 1mA      I<sub>C</sub> = 0mA</b>	<b>3.5</b>	---	---	<b>V</b>
<b>I<sub>CES</sub></b>	<b>V<sub>CE</sub> = 50V      I<sub>E</sub> = 0mA</b>	---	---	<b>2</b>	<b>mA</b>

**DYNAMIC**

Symbol	Test Conditions	Value			Unit
		Min.	Typ.	Max.	
<b>P<sub>OUT</sub></b>	<b>f = 1025 - 1150 MHz    P<sub>IN</sub> = 1.5W    V<sub>CC</sub> = 50V</b>	<b>15</b>	---	---	<b>W</b>
<b>G<sub>p</sub></b>	<b>f = 1025 - 1150 MHz    P<sub>IN</sub> = 1.5W    V<sub>CC</sub> = 50V</b>	<b>10</b>	---	---	<b>dB</b>
<b>η<sub>c</sub></b>	<b>f = 1025 - 1150 MHz    P<sub>IN</sub> = 1.5W    V<sub>CC</sub> = 50V</b>	<b>30</b>	---	---	<b>%</b>

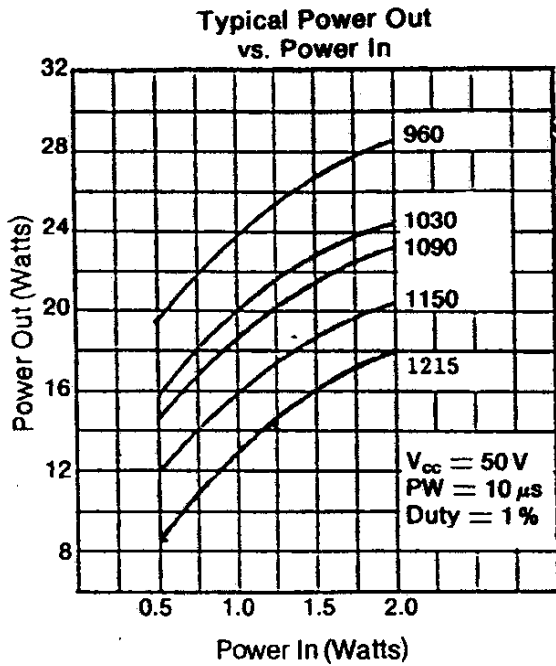
**Conditions:      Pulse Width = 10 μSec    Duty Cycle = 1%**
**IMPEDANCE DATA**

FREQ	Z <sub>IN</sub> (Ω)	Z <sub>CL</sub> (Ω)
<b>1025 MHz</b>	<b>3.0 + j5.0</b>	<b>5.8 + j7.5</b>
<b>1090 MHz</b>	<b>3.8 + j7.5</b>	<b>3.3 + j8.5</b>
<b>1150 MHz</b>	<b>2.5 + j20.0</b>	<b>6.0 + j8.9</b>

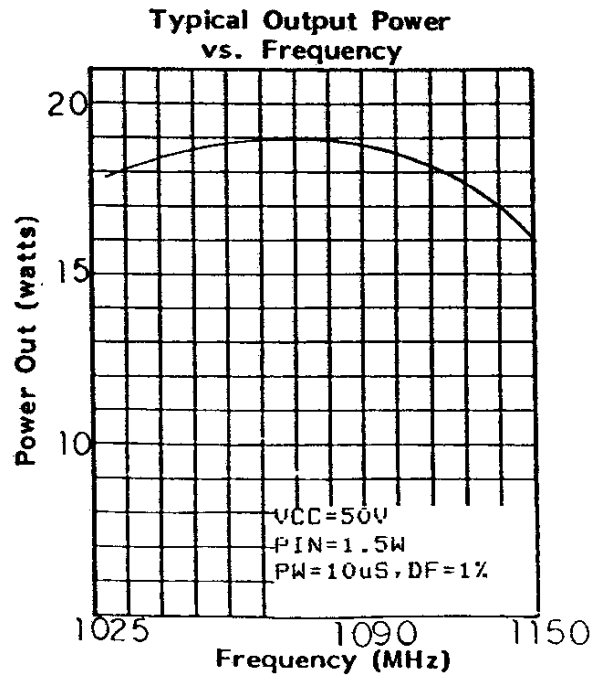
**V<sub>CC</sub> = 50V**  
**P<sub>IN</sub> = 1.5W**

**TYPICAL PERFORMANCE**

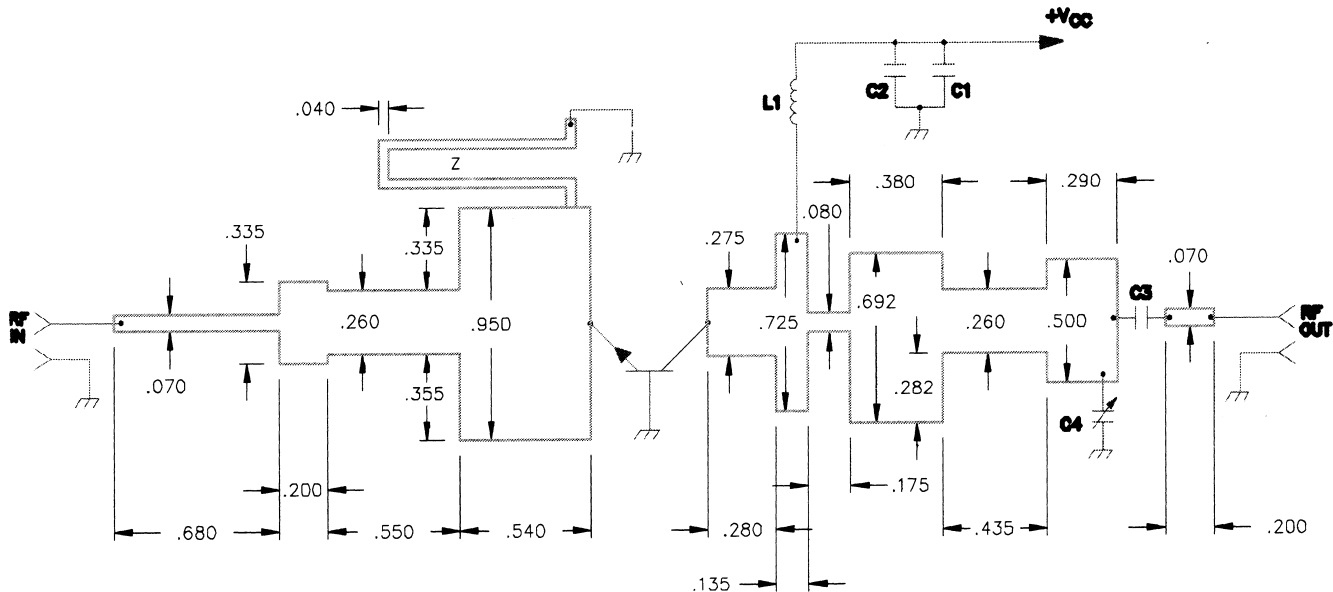
**POWER OUTPUT vs POWER INPUT**



**POWER OUTPUT vs FREQUENCY**



TEST CIRCUIT

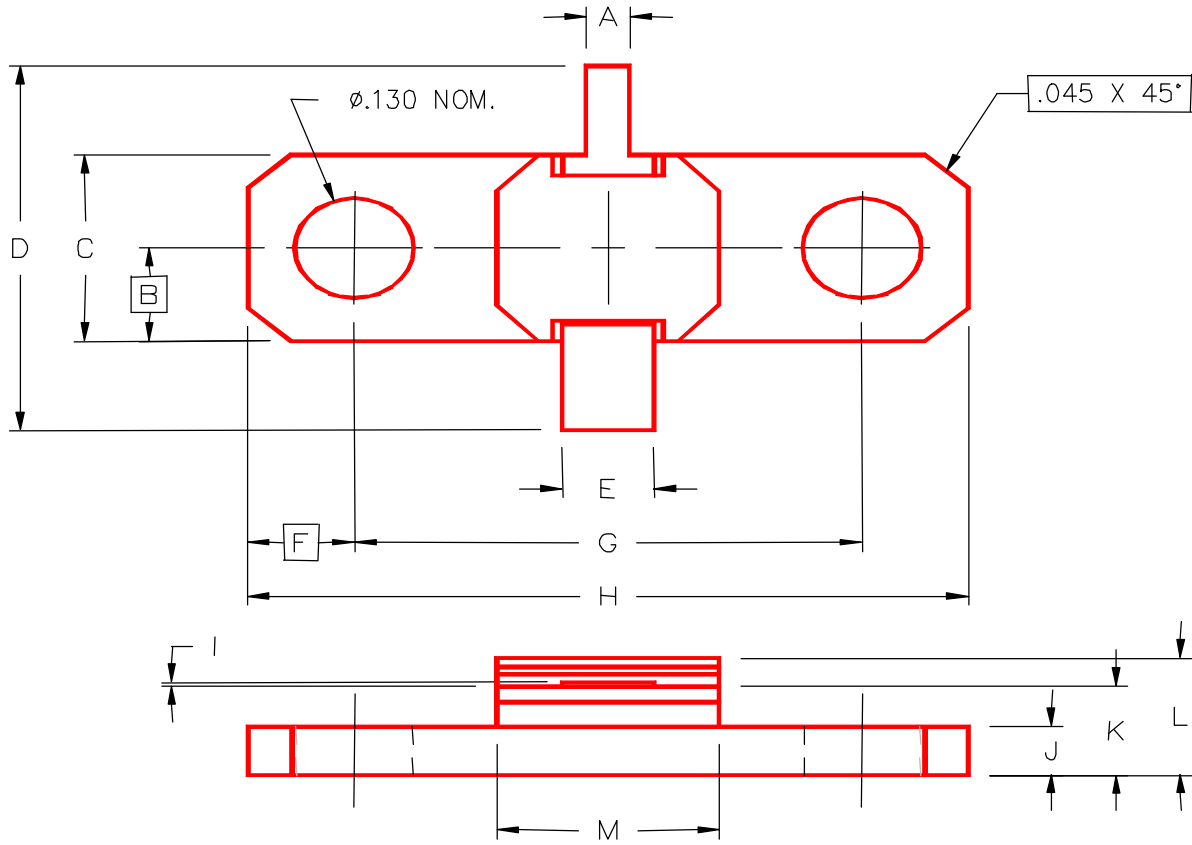


- C1 : 1000 $\mu$ F Electrolytic  
 C2 : 680pF Chip Capacitor  
 C3 : 120pF Chip Capacitor  
 C4 : 0.6 - 4.5pF Johanson Gigatrim
- L1 : 6 1/2 Turns, #22 AWG on a #30 Drill Bit  
 Z : Printed Transmission Line, Length = 1.91"
- Board : Er = 2.5, .034" Thick  
 All Dimensions are in Inches.

**MS2321**

**PACKAGE MECHANICAL DATA**

**PACKAGE STYLE M105**



	MINIMUM INCHES/MM	MAXIMUM INCHES/MM		MINIMUM INCHES/MM	MAXIMUM INCHES/MM
A	.045/1,14	.055/1,40	I	.002/0,05	.006/0,15
B	.125/3,18		J	.057/1,45	.067/1,70
C	.245/6,22	.255/6,48	K	.112/2,84	.132/3,35
D	1.235/31,37		L		.175/4,45
E	.095/2,41	.105/2,67	M	.245/6,48	.405/10,29
F	.120/3,05				
G	.557/14,15	.567/14,40			
H	.795/20,19	.805/20,45			